

Silicon Carbide Power Schottky Diode

Features

- Industry's leading low leakage currents
- 175 °C maximum operating temperature
- Temperature independent switching behavior
- Superior surge current capability
- Positive temperature coefficient of V_F
- Extremely fast switching speeds
- Superior figure of merit Q_C/I_F

Advantages

- Low standby power losses
- Improved circuit efficiency (Lower overall cost)
- Low switching losses
- Ease of paralleling devices without thermal runaway
- Smaller heat sink requirements
- Low reverse recovery current
- Low device capacitance
- Low reverse leakage current at operating temperature

Maximum Ratings at $T_j = 175^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Values	Unit
Repetitive peak reverse voltage	V_{RRM}		1200	V
Continuous forward current (Per Leg/Device)	I_F	$T_C = 25^\circ\text{C}$	12/24	A
Continuous forward current (Per Leg/Device)	I_F	$T_C \leq 150^\circ\text{C}$	5/10	A
RMS forward current (Per Leg/Device)	$I_{F(RMS)}$	$T_C \leq 150^\circ\text{C}$	8/16	A
Surge non-repetitive forward current, Half Sine Wave	$I_{F,SM}$	$T_C = 25^\circ\text{C}, t_p = 10\text{ ms}$	32	A
		$T_C = 150^\circ\text{C}, t_p = 10\text{ ms}$	26	
Non-repetitive peak forward current	$I_{F,max}$	$T_C = 25^\circ\text{C}, t_p = 10\text{ }\mu\text{s}$	120	A
I^2t value	$\int I^2 dt$	$T_C = 25^\circ\text{C}, t_p = 10\text{ ms}$	5	A^2s
		$T_C = 150^\circ\text{C}, t_p = 10\text{ ms}$	3.4	
Power dissipation (Per Leg/Device)	P_{tot}	$T_C = 25^\circ\text{C}$	117/234	W
Operating and storage temperature	T_j, T_{stg}		-55 to 175	°C

Electrical Characteristics at $T_j = 175^\circ\text{C}$, unless otherwise specified (Per Leg)

Parameter	Symbol	Conditions	Values			Unit
			min.	typ.	max.	
Diode forward voltage	V_F	$I_F = 5\text{ A}, T_j = 25^\circ\text{C}$	1.6	1.9	2.6	V
		$I_F = 5\text{ A}, T_j = 175^\circ\text{C}$		3.0		
Reverse current	I_R	$V_R = 1200\text{ V}, T_j = 25^\circ\text{C}$	5	50	10	μA
		$V_R = 1200\text{ V}, T_j = 175^\circ\text{C}$		100		
Total capacitive charge	Q_C	$I_F \leq I_{F,MAX}$ $dI_F/dt = 200\text{ A}/\mu\text{s}$ $T_j = 175^\circ\text{C}$	$V_R = 400\text{ V}$ $V_R = 960\text{ V}$	21 35		nC
Switching time	t_s		$V_R = 400\text{ V}$ $V_R = 960\text{ V}$	< 25		ns
Total capacitance	C	$V_R = 1\text{ V}, f = 1\text{ MHz}, T_j = 25^\circ\text{C}$	260			pF
		$V_R = 400\text{ V}, f = 1\text{ MHz}, T_j = 25^\circ\text{C}$	25			
		$V_R = 1000\text{ V}, f = 1\text{ MHz}, T_j = 25^\circ\text{C}$	20			

Thermal Characteristics

Thermal resistance, junction - case	R_{thJC}	1.4 *	°C/W
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Mechanical Properties

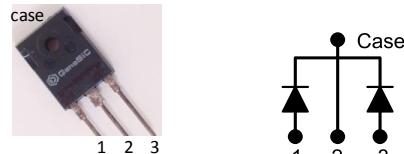
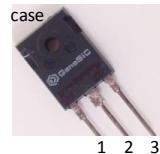
Mounting torque	M	0.6	Nm
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* Per Leg, ** Per Device

V_{RRM}	= 1200 V
$I_F (T_c = 25^\circ\text{C})$	= 24 A **
$I_F (T_c \leq 150^\circ\text{C})$	= 10 A **
Q_C	= 21 nC *

Package

- RoHS Compliant



TO - 247

Applications

- Power Factor Correction (PFC)
- Switched-Mode Power Supply (SMPS)
- Solar Inverters
- Wind Turbine Inverters
- Motor Drives
- Induction Heating
- Uninterruptible Power Supply (UPS)
- High Voltage Multipliers

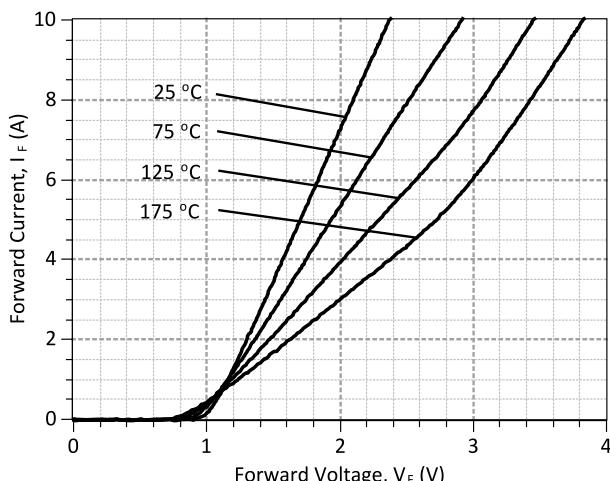


Figure 1: Typical Forward Characteristics (Per Leg)

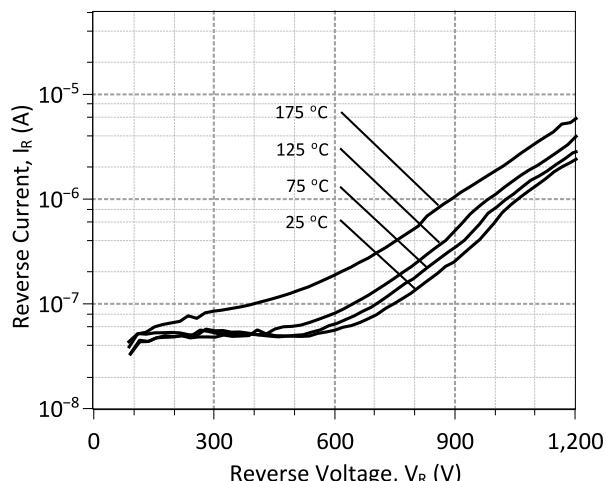


Figure 2: Typical Reverse Characteristics (Per Leg)

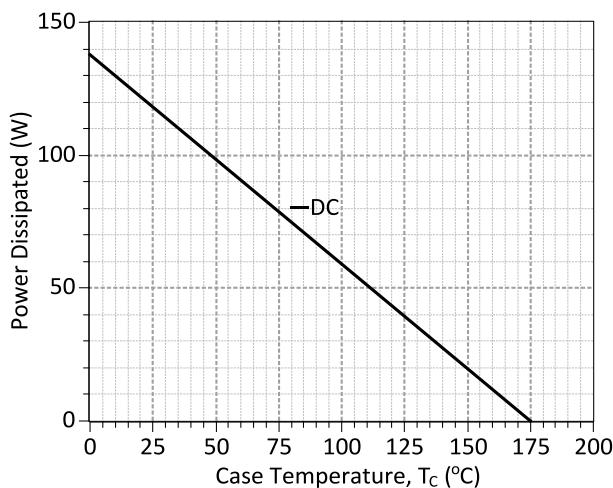


Figure 3: Power Derating Curve (Per Leg)

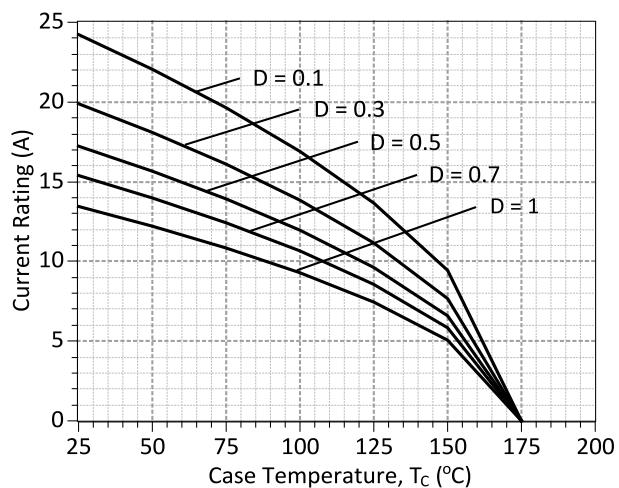


Figure 4: Current Derating Curves ($D = t_p/T$, $t_p = 400 \mu s$)
 (Considering worst case Z_{th} conditions) (Per Leg)

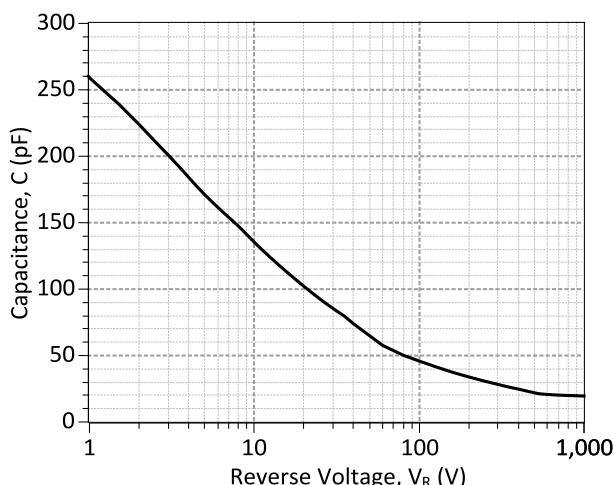


Figure 5: Typical Junction Capacitance vs Reverse Voltage Characteristics (Per Leg)

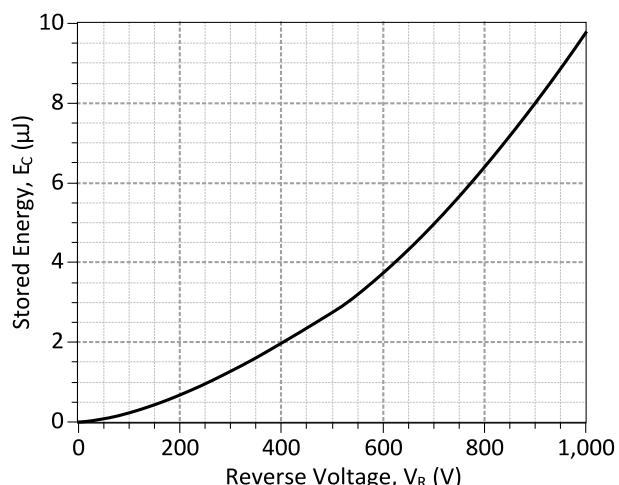


Figure 6: Typical Capacitive Energy vs Reverse Voltage Characteristics (Per Leg)

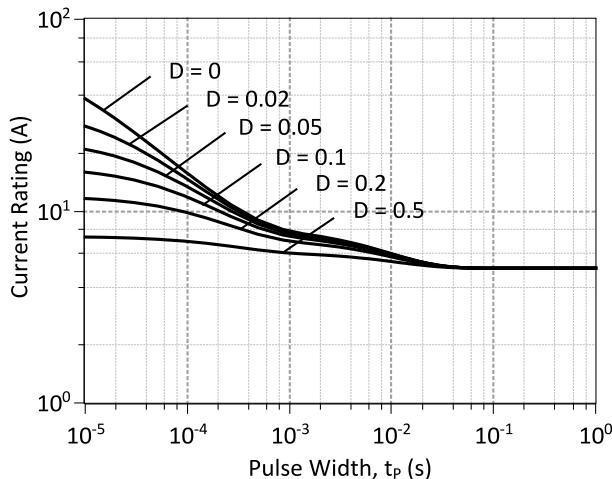


Figure 7: Current vs Pulse Duration Curves at $T_c = 155\text{ }^\circ\text{C}$
(Per Leg)

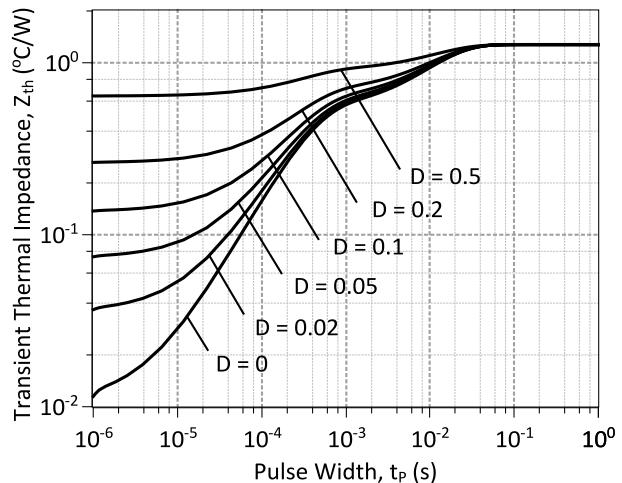
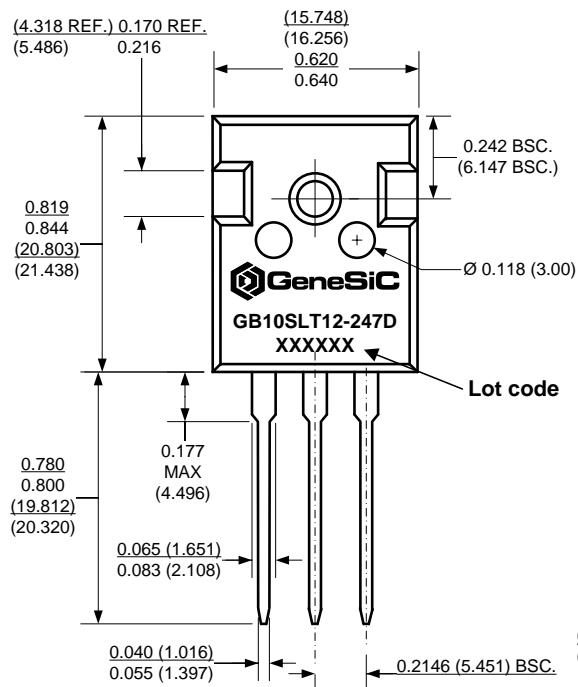


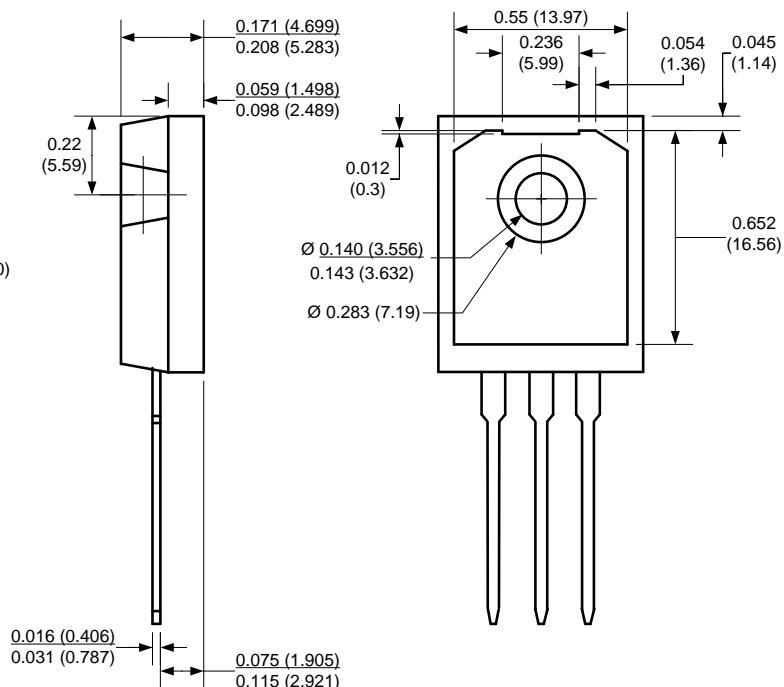
Figure 8: Transient Thermal Impedance (Per Leg)

Package Dimensions:

TO-247



PACKAGE OUTLINE



NOTE

1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS



GB10SLT12-247D

Revision History

Date	Revision	Comments	
2015/09/16	0	Initial release	

Published by

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SPICE Model Parameters

This is a secure document. Please copy this code from the SPICE model PDF file on our website (http://www.genesicsemi.com/images/products_sic/rectifiers/GB10SLT12-247D_SPICE.pdf) into LTSpice (version 4) software for simulation of the GB10SLT12-247D. All the simulations are per Leg.

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*      MODEL OF GeneSiC Semiconductor Inc.
*
*      $Revision:    1.0          $
*      $Date:     16-SEP-2015      $
*
*      GeneSiC Semiconductor Inc.
*      43670 Trade Center Place Ste. 155
*      Dulles, VA 20166
*
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*
* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
* OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
* PARTICULAR PURPOSE."
* Models accurate up to 2 times rated drain current.
*
* Start of GB10SLT12-247D SPICE Model
*
.SUBCKT GB10SLT12D ANODE KATHODE
R1 ANODE INT R=((TEMP-24)*0.0015); Temperature Dependant Resistor
D1 INT KATHODE GB10SLT12D_25C; Call the 25C Diode Model
D2 ANODE KATHODE GB10SLT12D_PIN; Call the PiN Diode Model
.MODEL GB10SLT12D_25C D
+ IS      5.83E-18      RS      0.1276
+ N       1             IKF     602
+ EG      1.2           XTI     3
+ CJO     3.00E-10      VJ      0.419
+ M       1.6           FC      0.5
+ TT      1.00E-10      BV      1200
+ IBV     1.00E-03      VPK     1200
+ IAVE    5              TYPE    SiC_Schottky
+ MFG     GeneSiC_Semiconductor
.MODEL GB10SLT12D_PIN D
+ IS      3.50 E-12      RS      0.3648
+ N       4.409          IKF     73
+ EG      3.23           XTI     -6
+ FC      0.5            TT      0
+ BV      1200            IBV     1.00E-03
+ VPK     1200            IAVE    1
+ TYPE    SiC_PiN
.ENDS
*
* End of GB10SLT12-247D SPICE Model

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